

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Lin et al.

Docket No.: TI-31518

Serial No: TBD

Examiner: TBD

Filed: 10/11/01

Art Unit: TBD

For: ELIMINATION OF OVERHANG IN LINER/BARRIER/SEED LAYERS
USING POST-DEPOSITION SPUTTER ETCH

PRELIMINARY AMENDMENT

October 11, 2001

Assistant Commissioner for Patents

Washington, DC 20231

Dear Sir:

Please amend the above referenced application as follows:

In the Specification:

Page 1, before line 1, insert --This application claims priority under 35 USC §
119(e)(1) of provisional application numbers 60/249,106 filed 11/16/00.--